B SHOULDER

规格书编号 SPEC NO: HDR378.3MS6SP01

产品规格书(预期) Preliminary SPECIFICATION

CUSTOMER 客户:				
PRODUCT 产品:	SAW RESONATOR			
MODEL NO 型 号:	HDR378.3M-S6			
PREPARED 编制:	CHECKED 审 核:			
APPROVED 批 准:	DATE日期: 2018-9-10			

客户确认 CUSTOMER RECEIVED:						
批准 APPROVED	日期 DATE					

无锡市好达电子有限公司 Shoulder Electronics Limited



HDR378.3M-S6

更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark



1. Scope

This specification shall cover the characteristics of 1-port SAW resonator with R378.3M used for remote-control security.

2. Electrical Specification

2.1 Maximum Rating

DC Voltage VDC	10V
AC Voltage Vpp	10V 50Hz/60Hz
Operation temperature	-40°℃ to +85°℃
Storage temperature	-45°℃ to +85°℃
Max input Power	10dBm

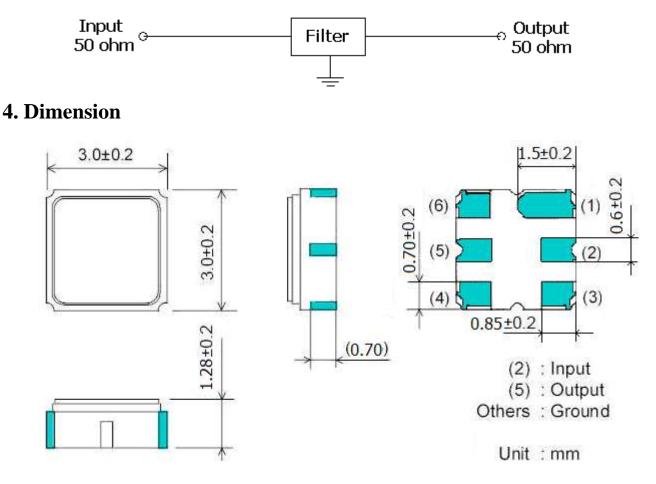
2.2 Electronic Characteristics

Item		Unites	Minimum	Typical	Maximum	
Center Frequency		MHz	378.225	378.300	378.375	
Insertion Loss		dB		1.5	2.5	
Quality Factor		Unload Q		8000	12000	
		50Ω Loaded Q		800	2000	
Temperature	Turnover Temperature		°C	10	25	40
Stability	Freq.temp.Coefficient		ppm/℃		0.032	
Frequency Aging		ppm/yr		<±10		
DC. Insulation Resistance		MΩ	1.0			
Transducer Static Capacitance C0		pF		2.3		



SAW RESONATOR

3. Test Circuit



5. Environment Characteristic

5-1 High temperature exposure

Subject the device to $+85^{\circ}$ C for 16 hours. Then release the resonator into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

5-2 Low temperature exposure

Subject the device to -40° C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

5-3 Temperature cycling

Subject the device to a low temperature of -40° C for 30 minutes. Following by a high temperature of $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 2.2.

5-4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at 260° C $\pm 10^{\circ}$ C for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2.2.

5-5 Solderability

Subject the device terminals into the solder bath at 245 $^\circ C$ $\pm 5 \,^\circ C$ for 5s, More than 95%

area of the terminals must be covered with new solder. It shall meet the specifications in 2.2.

5-6 Mechanical shock

SAW RESONATOR

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2.2.

5-7 Vibration

Subject the device to the vibration for 1 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2.2.

6. Remark

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.